SI5905BDC-T1-GE3 Datasheet

https://www.DiGi-Electronics.com

DiGi Electronics Part Number	SI5905BDC-T1-GE3-DG
Manufacturer	Vishay Siliconix
Manufacturer Product Number	SI5905BDC-T1-GE3
Description	MOSFET 2P-CH 8V 4A 1206-8
Detailed Description	Mosfet Array 8V 4A 3.1W Surface Mount 1206-8 Chi pFET™

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Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
SI5905BDC-T1-GE3	Vishay Siliconix
Series:	Product Status:
TrenchFET®	Obsolete
Technology:	Configuration:
MOSFET (Metal Oxide)	2 P-Channel (Dual)
FET Feature:	Drain to Source Voltage (Vdss):
Logic Level Gate	8V
Current - Continuous Drain (Id) @ 25°C:	Rds On (Max) @ Id, Vgs:
4A	80mOhm @ 3.3A, 4.5V
Vgs(th) (Max) @ Id:	Gate Charge (Qg) (Max) @ Vgs:
1V @ 250µA	11nC @ 8V
Input Capacitance (Ciss) (Max) @ Vds:	Power - Max:
350pF @ 4V	3.1W
Operating Temperature:	Mounting Type:
-55°C ~ 150°C (TJ)	Surface Mount
Package / Case:	Supplier Device Package:
8-SMD, Flat Lead	1206-8 ChipFET™
Base Product Number:	
SI5905	

Environmental & Export classification

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	
8541.29.0095	

Si5905BDC

Vishay Siliconix

Dual P-Channel 8 V (D-S) MOSFET

PRODUCT SUMMARY			
V_{DS} (V)	$R_{DS(on)}$ (Ω)	I_D (A)	Q_g (Typ.)
- 8	0.080 at V_{GS} = - 4.5 V	- 4[a]	4 nC
	0.117 at V_{GS} = - 2.5 V	- 4[a]	
	0.170 at V_{GS} = - 1.8 V	- 3.5	

FEATURES

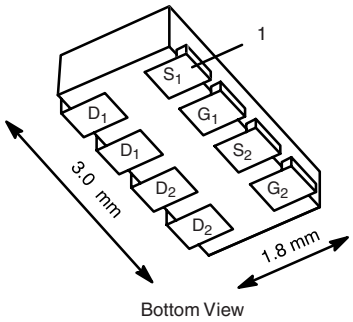
- **Halogen-free According to IEC 61249-2-21 Definition**
- TrenchFET® Power MOSFETs
- Compliant to RoHS Directive 2002/95/EC

Pb-free
RoHS COMPLIANT
HALOGEN FREE Available

APPLICATIONS

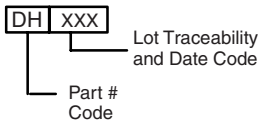
- Load Switch for Portable Devices

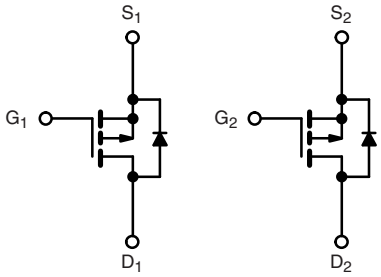
1206-8 ChipFET® (Dual)



Bottom View

Marking Code





P-Channel MOSFET P-Channel MOSFET

Ordering Information: Si5905BDC-T1-E3 (Lead (Pb)-free)
Si5905BDC-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS T_A = 25 °C, unless otherwise noted				
Parameter		**Symbol**	**Limit**	**Unit**
Drain-Source Voltage		V_{DS}	- 8	V
Gate-Source Voltage		V_{GS}	± 8	
Continuous Drain Current (T_J = 150 °C)	T_C = 25 °C	I_D	- 4[a]	A
	T_C = 70 °C		- 4[a]	
	T_A = 25 °C		- 3.5[b, c]	
	T_A = 70 °C		- 2.8[b, c]	
Pulsed Drain Current		I_{DM}	- 10	
Continuous Source-Drain Diode Current	T_C = 25 °C	I_S	- 2.6	
	T_A = 25 °C		- 1.2[b, c]	
Maximum Power Dissipation	T_C = 25 °C	P_D	3.1	W
	T_C = 70 °C		2	
	T_A = 25 °C		1.5[b, c]	
	T_A = 70 °C		0.94[b, c]	
Operating Junction and Storage Temperature Range		T_J, T_{stg}	- 55 to 150	°C
Soldering Recommendations (Peak Temperature)[d, e]			260	

THERMAL RESISTANCE RATINGS					
Parameter		**Symbol**	**Typical**	**Maximum**	**Unit**
Maximum Junction-to-Ambient[b, f]	t ≤ 5 s	R_{thJA}	70	85	°C/W
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	33	40	

Notes:
a. Package limited.
b. Surface mounted on 1" x 1" FR4 board.
c. t = 5 s.
d. See Solder Profile (www.vishay.com/ppg?73257). The 1206-8 ChipFET is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.
f. Maximum under Steady State conditions is 120 °C/W.

Si5905BDC

Vishay Siliconix

SPECIFICATIONS T_J = 25 °C, unless otherwise noted						
Parameter	**Symbol**	**Test Conditions**	**Min.**	**Typ.**	**Max.**	**Unit**
Static						
Drain-Source Breakdown Voltage	V_{DS}	V_{GS} = 0 V, I_D = - 250 µA	- 8			V
V_{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	I_D = - 250 µA		- 7		mV/°C
$V_{GS(th)}$ Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			2		
Gate-Source Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = - 250 µA	- 0.45		- 1.0	V
Gate-Source Leakage	I_{GSS}	V_{DS} = 0 V, V_{GS} = ± 8 V			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = - 8 V, V_{GS} = 0 V			- 1	µA
		V_{DS} = - 8 V, V_{GS} = 0 V, T_J = 85 °C			- 10	
On-State Drain Current[a]	$I_{D(on)}$	$V_{DS} \leq$ - 5 V, V_{GS} = - 4.5 V	- 10			A
Drain-Source On-State Resistance[a]	$R_{DS(on)}$	V_{GS} = - 4.5 V, I_D = 3.3 A		0.066	0.080	Ω
		V_{GS} = - 2.5 V, I_D = - 2.5 A		0.097	0.117	
		V_{GS} = - 1.8 V, I_D = - 0.6 A		0.140	0.170	
Forward Transconductance[a]	g_{fs}	V_{DS} = - 4 V, I_D = - 3.3 A		8		S
Dynamic[b]						
Input Capacitance	C_{iss}	V_{DS} = - 4 V, V_{GS} = 0 V, f = 1 MHz		350		pF
Output Capacitance	C_{oss}			140		
Reverse Transfer Capacitance	C_{rss}			85		
Total Gate Charge	Q_g	V_{DS} = - 4 V, V_{GS} = - 8 V, I_D = - 3.7 A		7	11	nC
		V_{DS} = - 4 V, V_{GS} = - 4.5 V, I_D = - 3.7 A		4	6	
Gate-Source Charge	Q_{gs}			0.65		
Gate-Drain Charge	Q_{gd}			0.75		
Gate Resistance	R_g	f = 1 MHz		5.5		Ω
Turn-On Delay Time	$t_{d(on)}$	V_{DD} = - 4 V, R_L = 1.3 Ω $I_D \cong$ - 3 A, V_{GEN} = - 4.5 V, R_g = 1 Ω		10	15	ns
Rise Time	t_r			25	40	
Turn-Off Delay Time	$t_{d(off)}$			20	30	
Fall Time	t_f			7	15	
Turn-On Delay Time	$t_{d(on)}$	V_{DD} = - 4 V, R_L = - 1.3 Ω $I_D \cong$ - 3 A, V_{GEN} = - 8 V, R_g = 1 Ω		5	10	
Rise Time	t_r			10	15	
Turn-Off Delay Time	$t_{d(off)}$			17	30	
Fall Time	t_f			10	15	
Drain-Source Body Diode Characteristics						
Continuous Source-Drain Diode Current	I_S	T_C = 25 °C			- 4	A
Pulse Diode Forward Current	I_{SM}				- 10	
Body Diode Voltage	V_{SD}	I_S = - 3 A, V_{GS} = 0 V		- 0.8	- 1.2	V
Body Diode Reverse Recovery Time	t_{rr}	I_F = - 3 A, dI/dt = 100 A/µs, T_J = 25 °C		55	85	ns
Body Diode Reverse Recovery Charge	Q_{rr}			25	50	nC
Reverse Recovery Fall Time	t_a			14		ns
Reverse Recovery Rise Time	t_b			41		

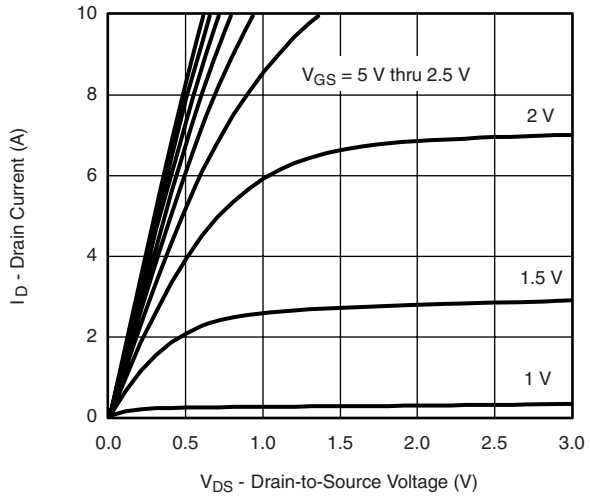
Notes:

a. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %.

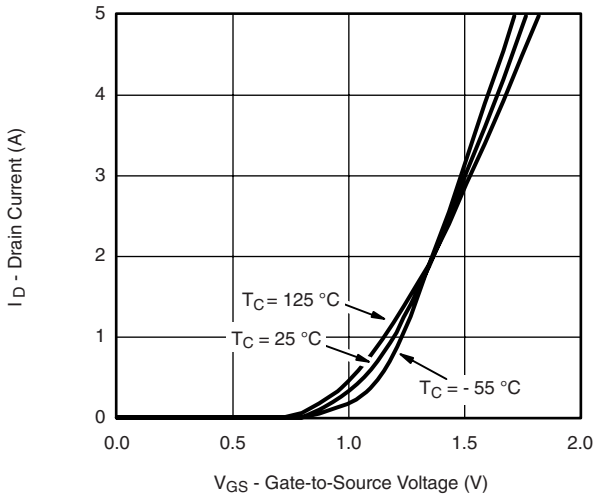
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

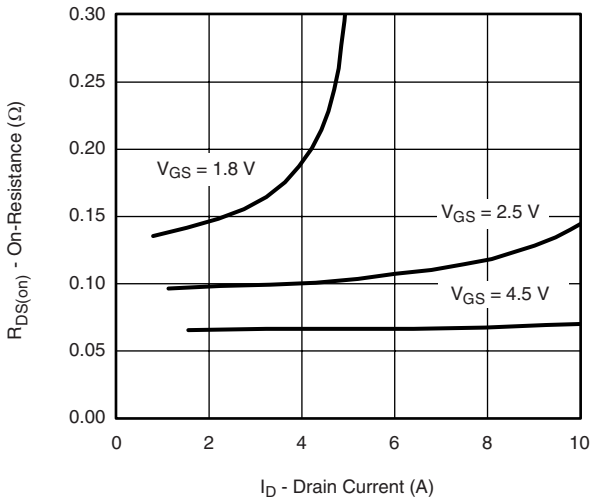
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



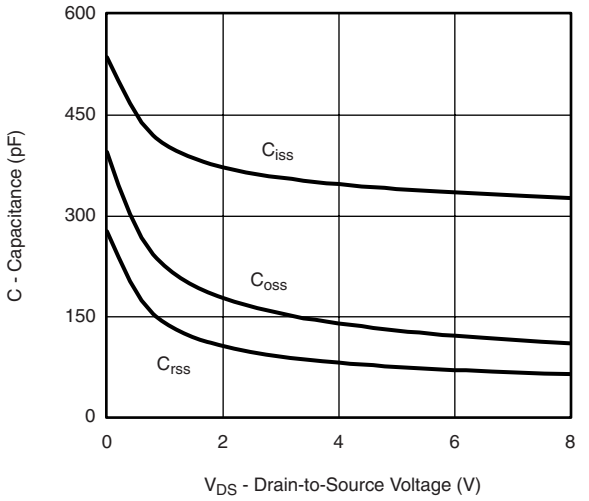
Output Characteristics



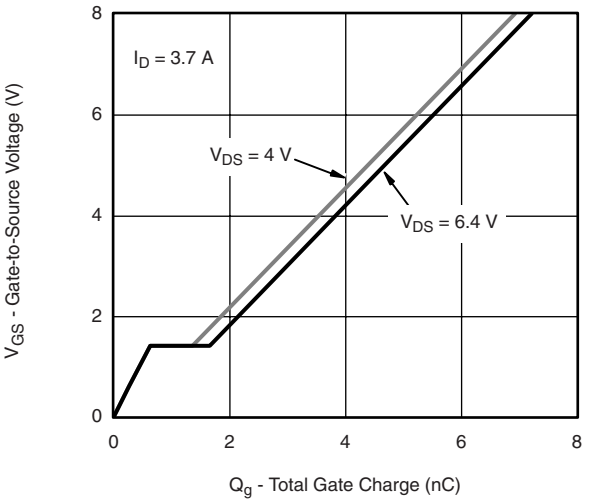
Transfer Characteristics



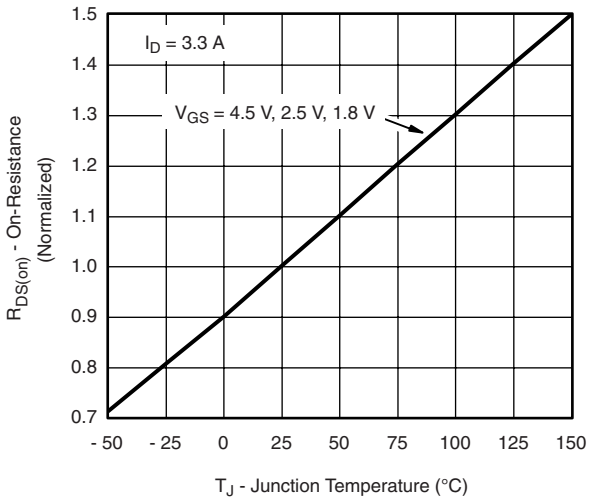
On Resistance vs. Drain Current



Capacitance

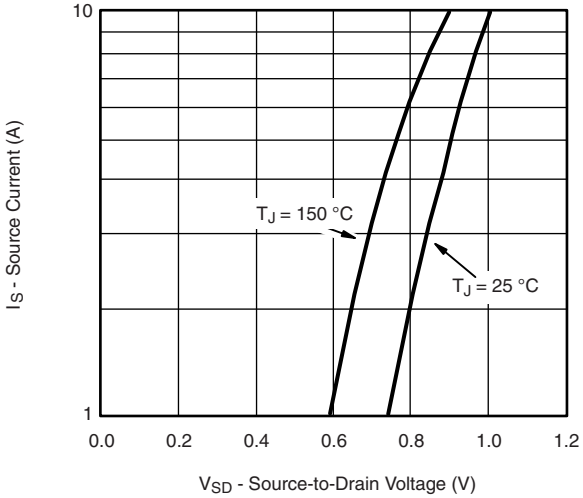


Gate Charge

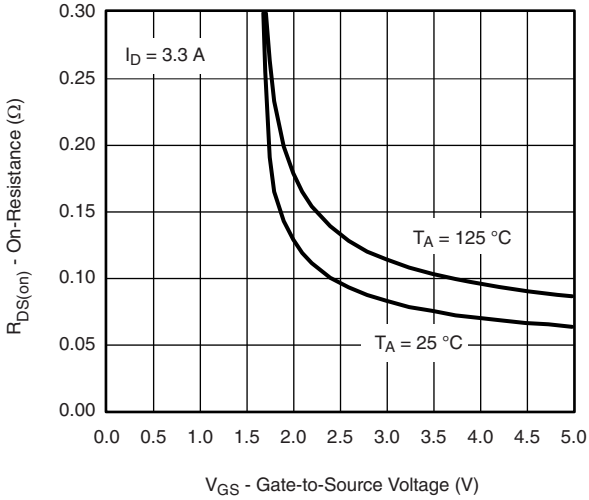


On-Resistance vs. Junction Temperature

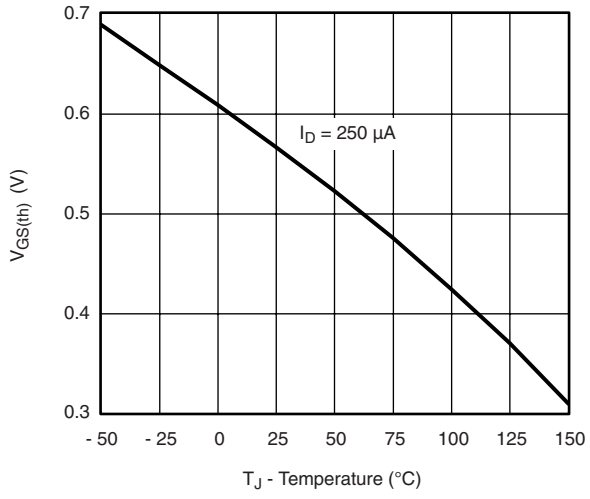
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



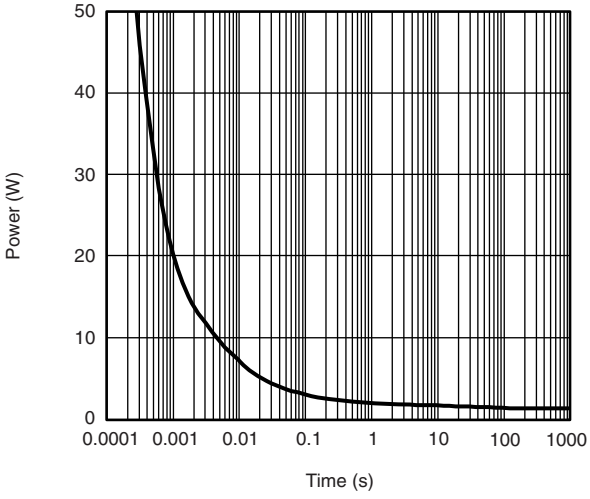
Forward Diode Voltage vs. Temperature



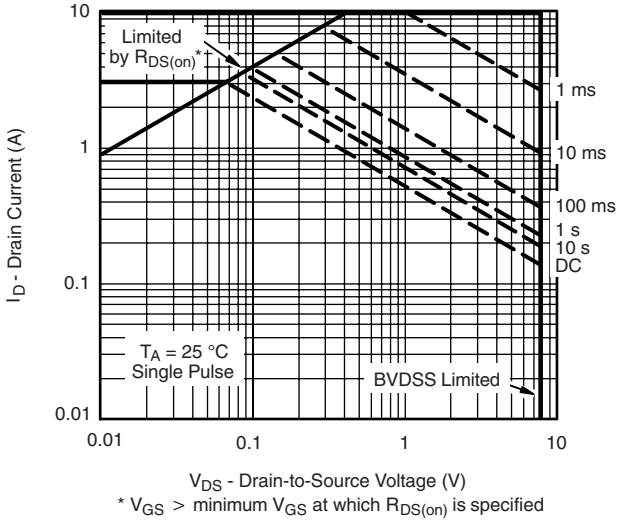
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



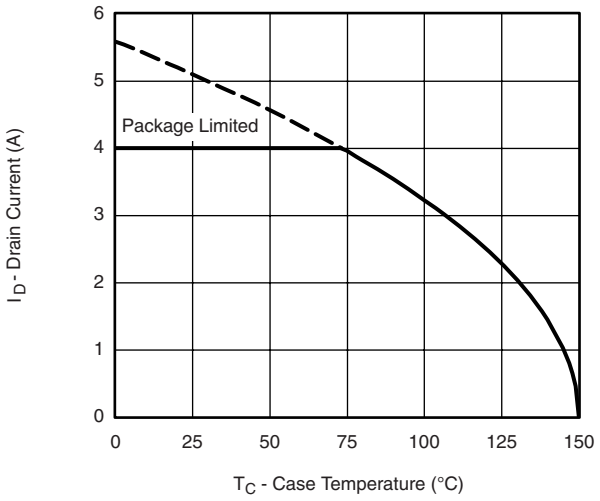
Single Pulse Power



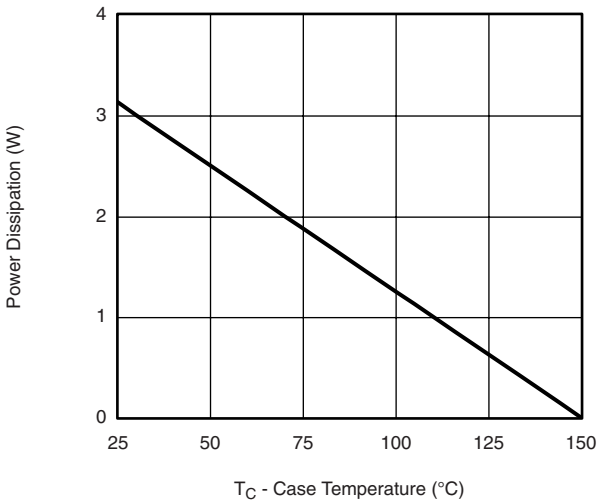
* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

Safe Operating Area, Junction-to-Ambient

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



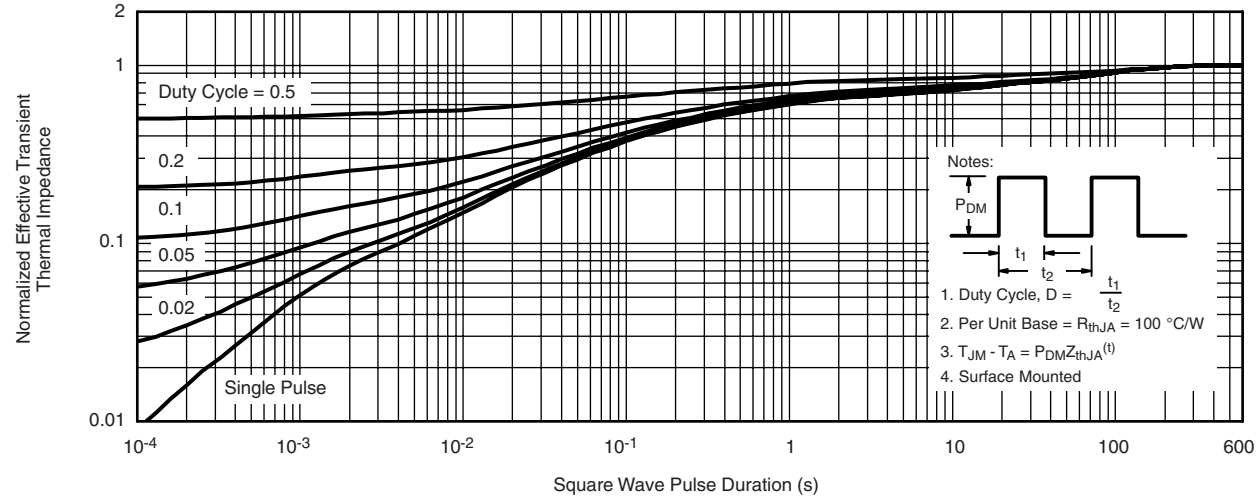
Current Derating*



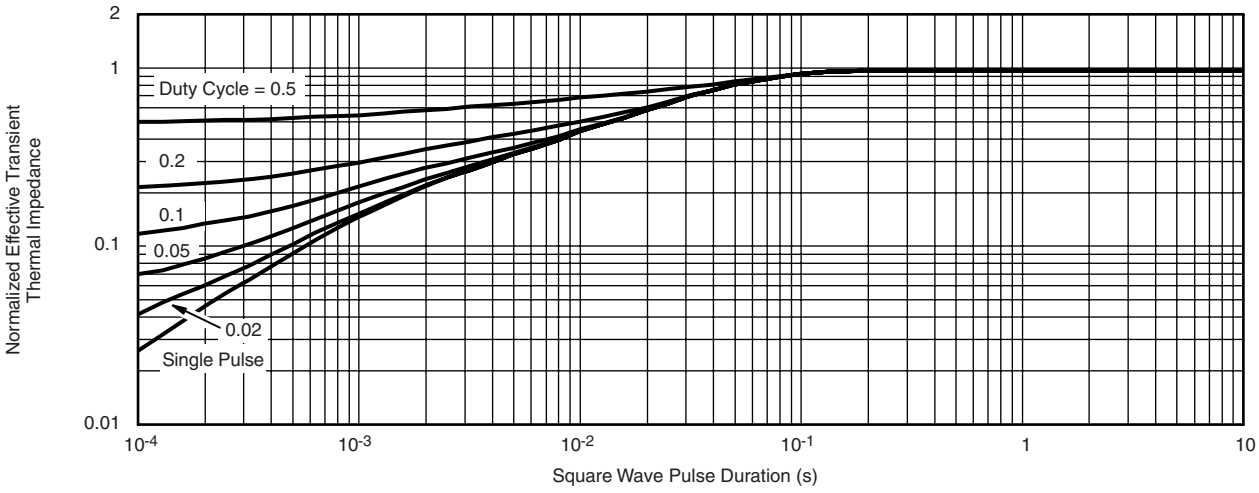
Power Derating

* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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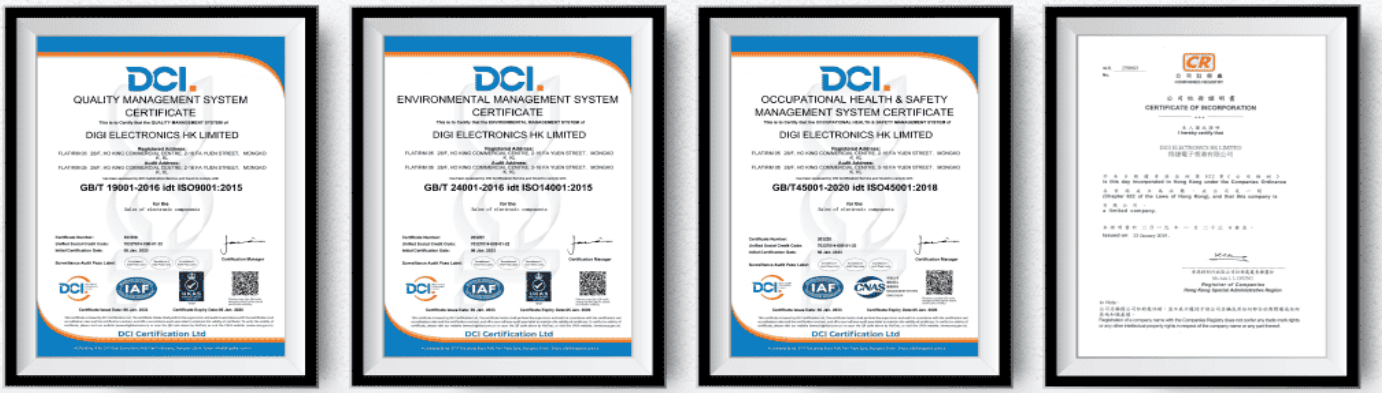

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